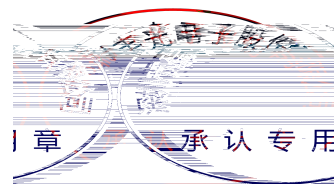


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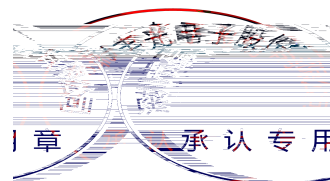


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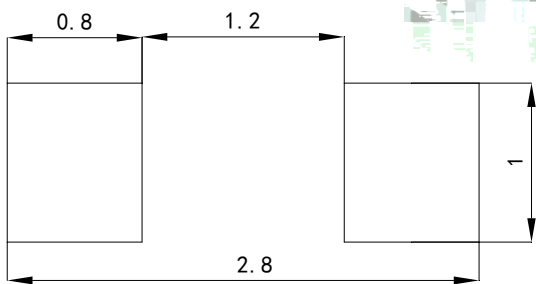
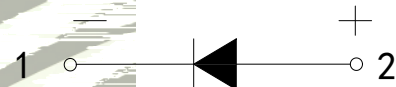
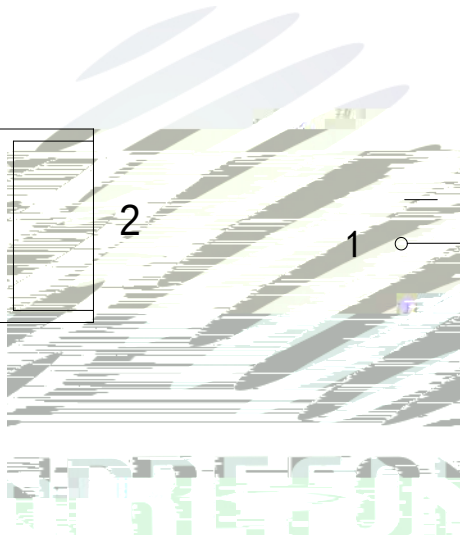
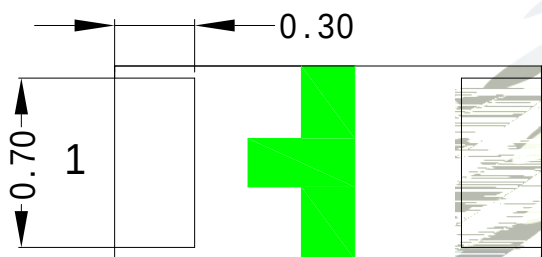
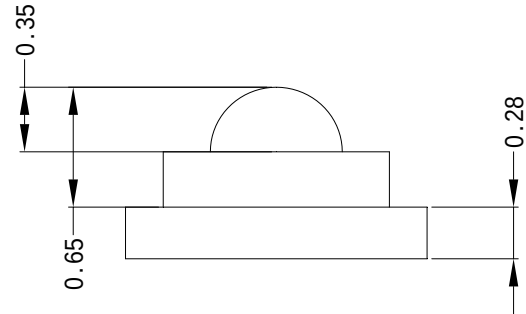
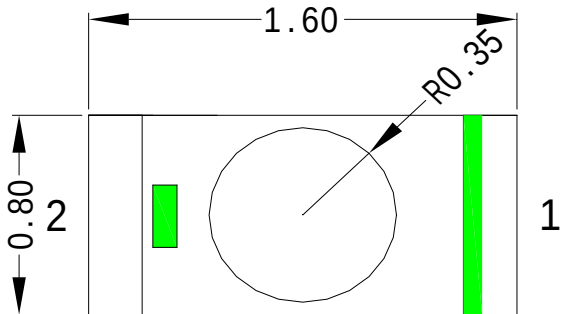
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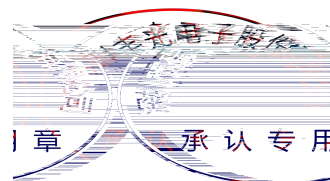


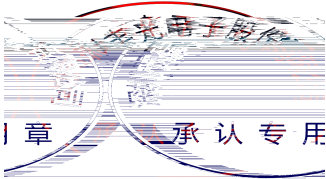
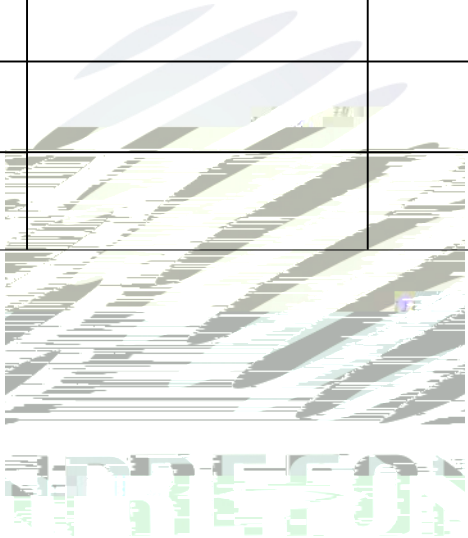
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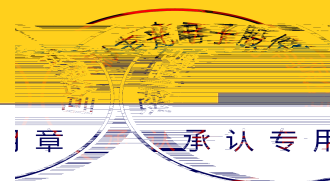
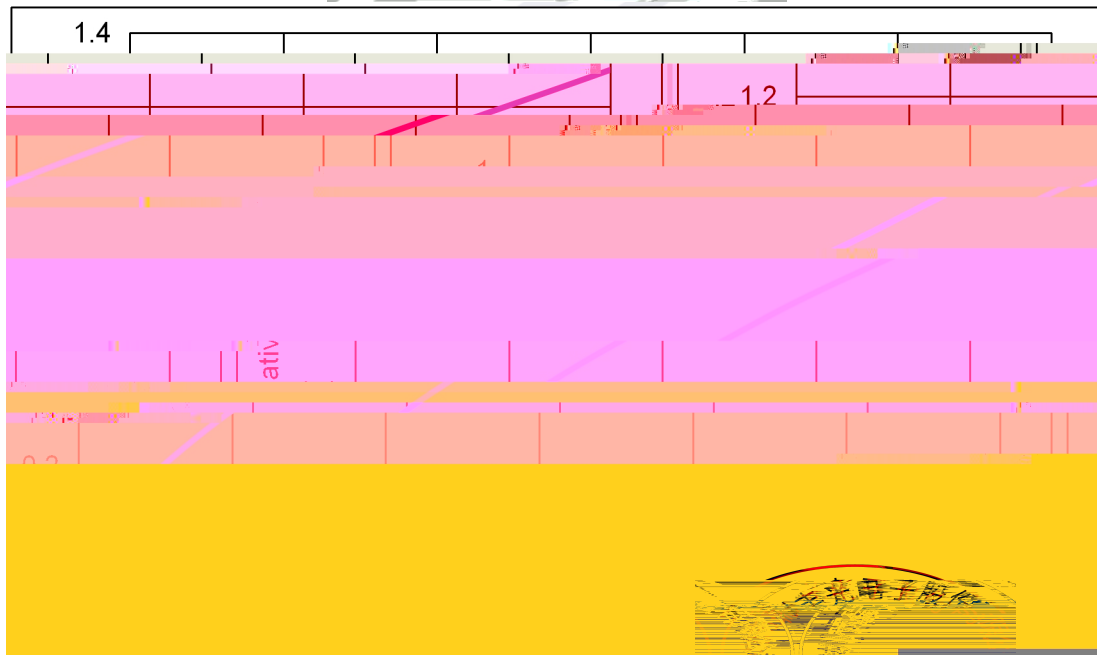
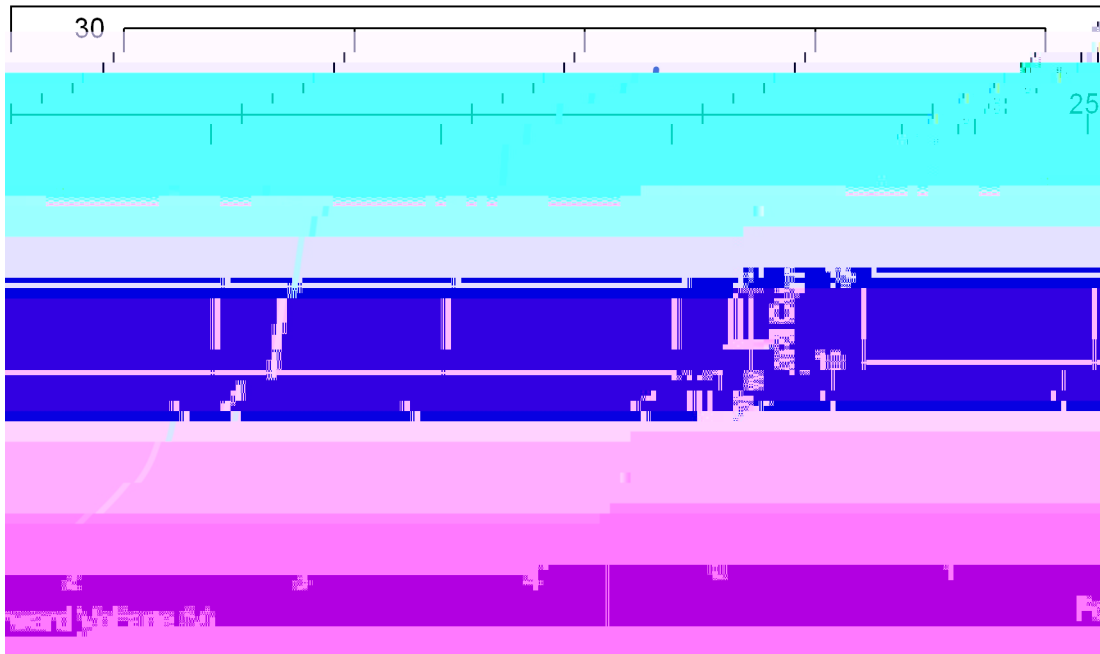
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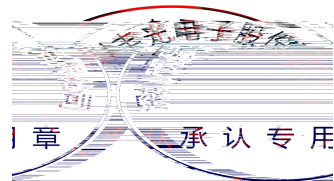


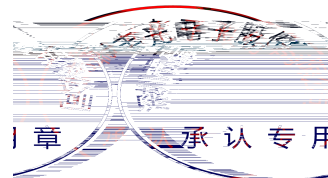
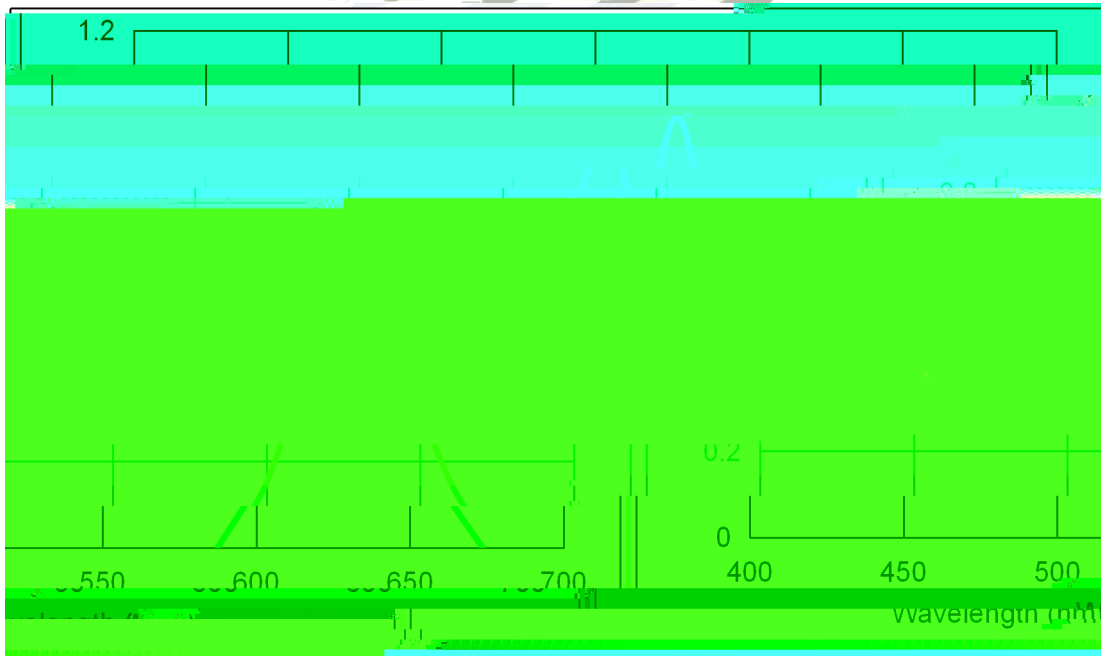
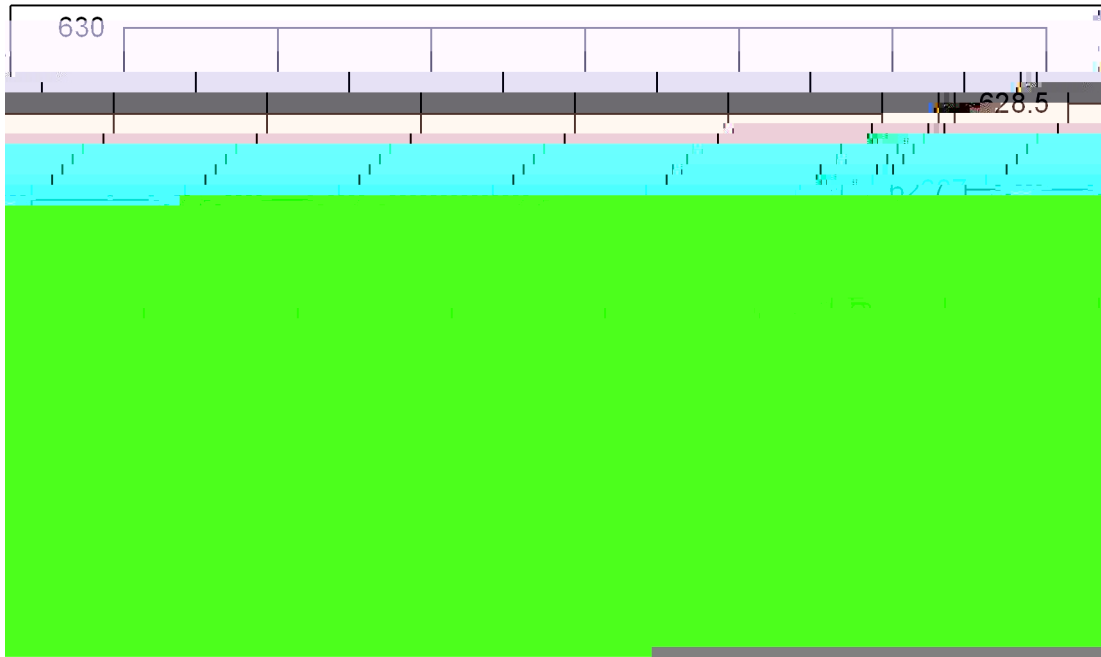


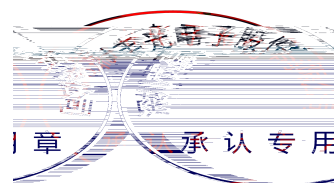
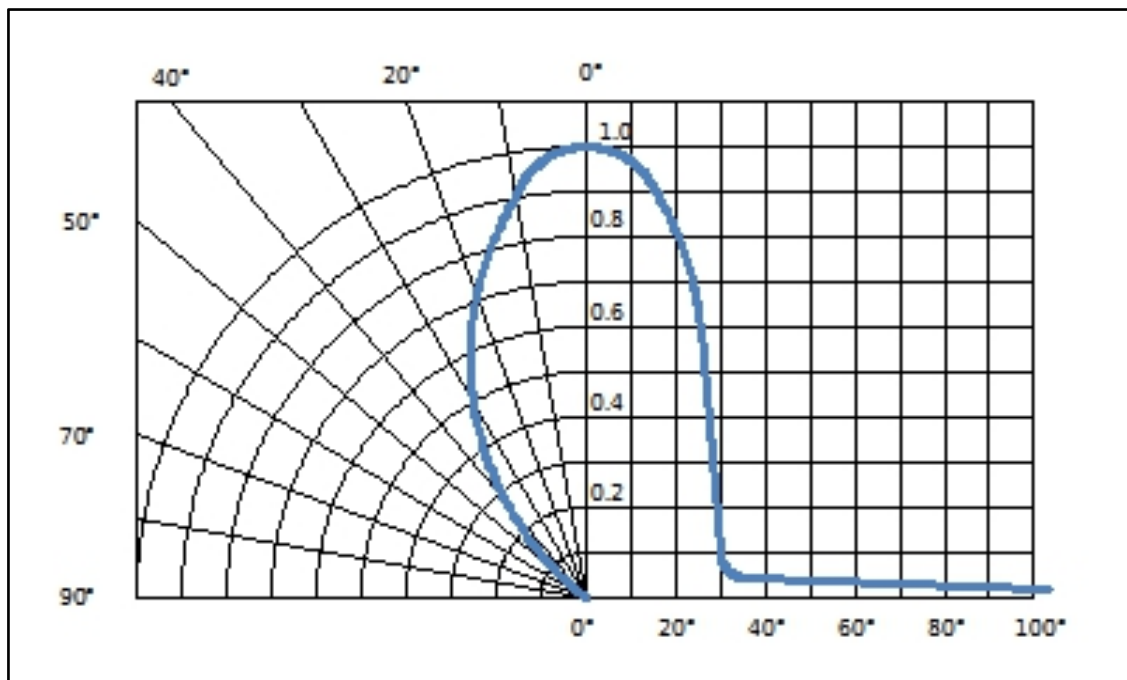
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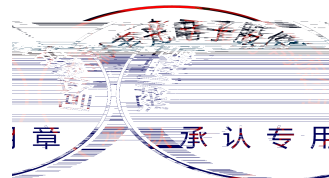
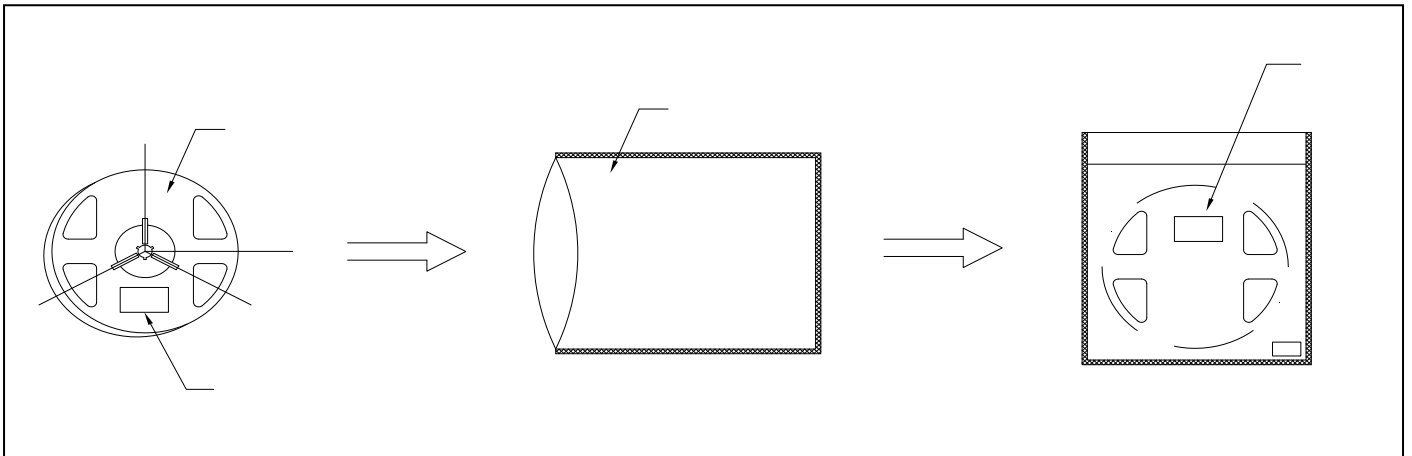


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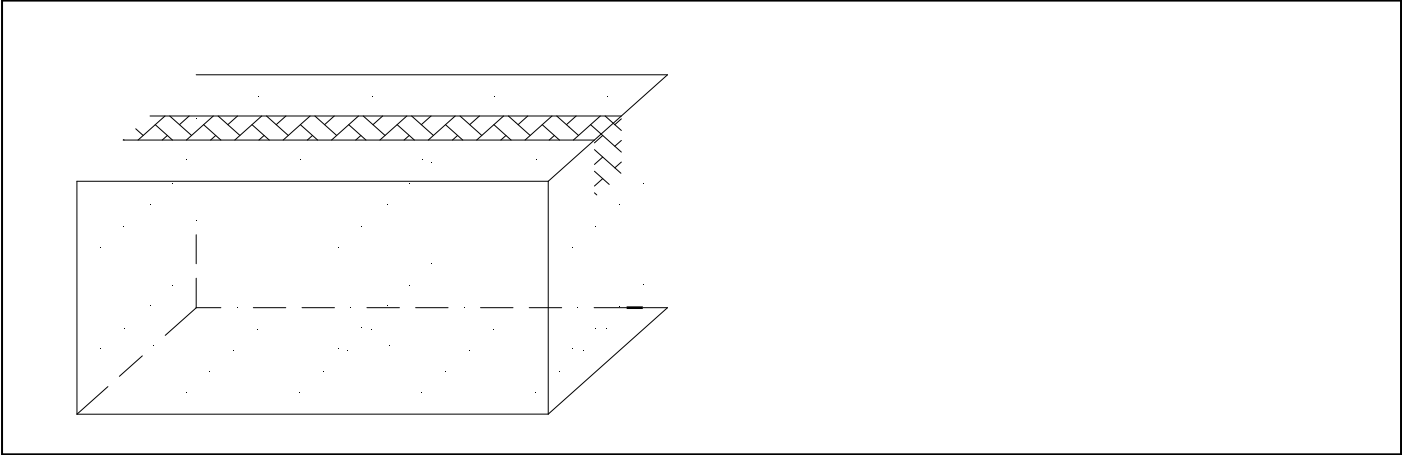




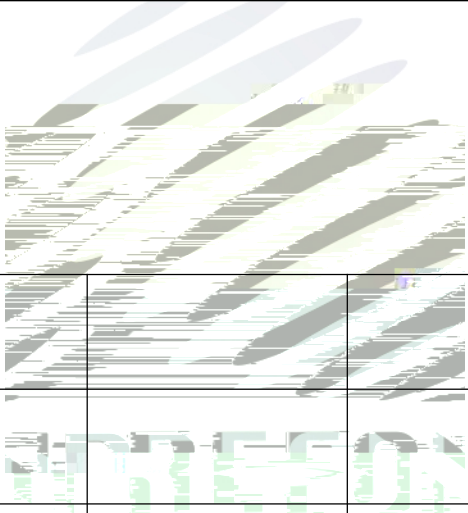
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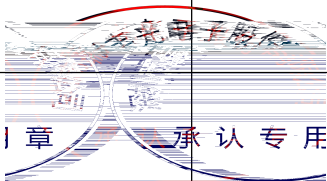


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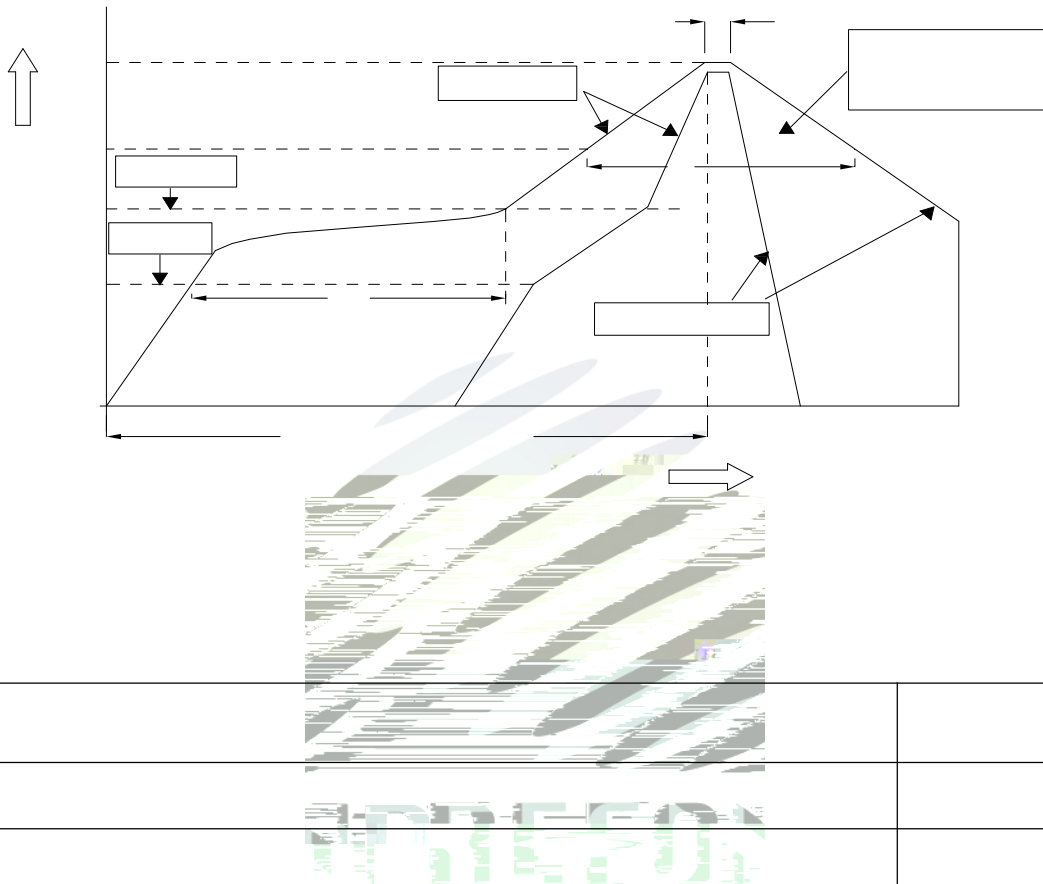
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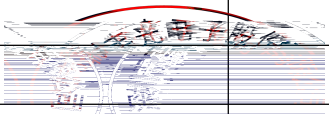
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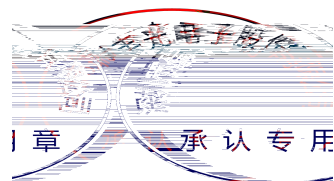
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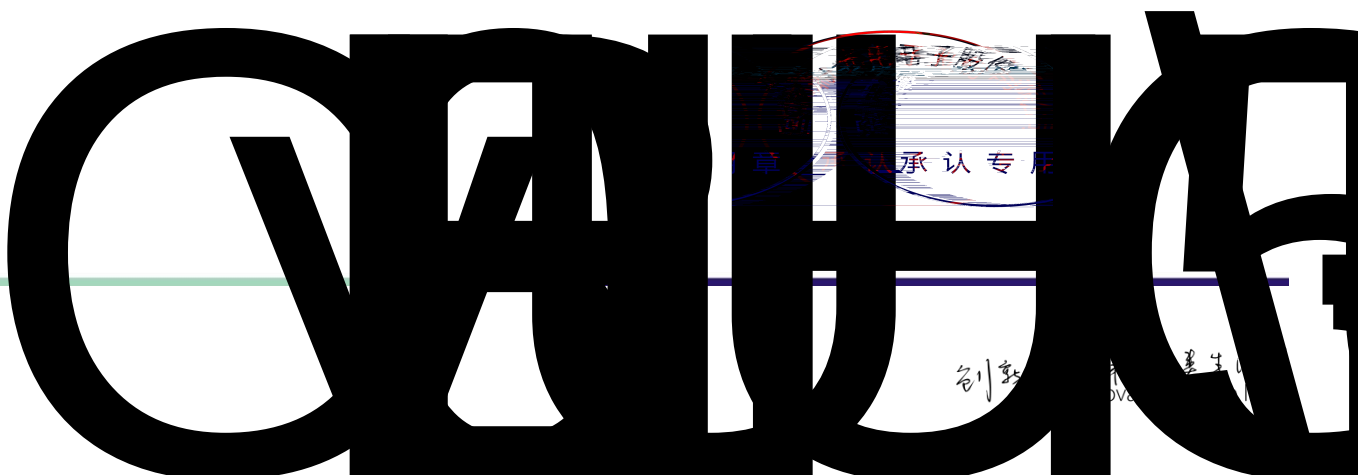
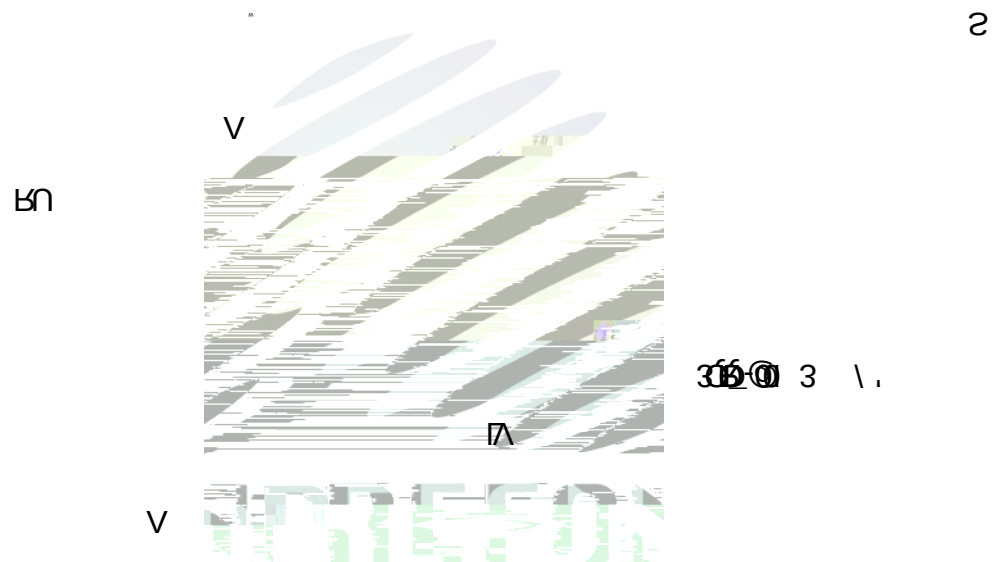


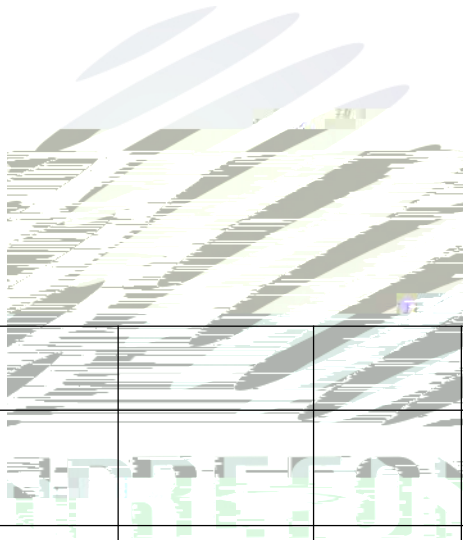
		
		
		
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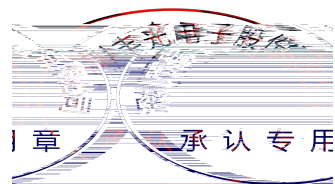


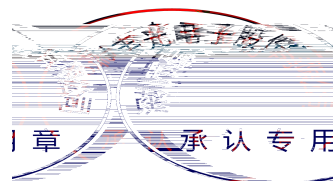
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